BLM7G1822S-80AB; BLM7G1822S-80ABG

Rev. 3 — 1 September 2015

AMPLEON Product data sheet

Product profile 1.

1.1 General description

The BLM7G1822S-80AB(G) is a dual section, asymmetric, 2-stage power MMIC using Ampleon's state of the art GEN7 LDMOS technology. This multiband device is perfectly suited as small cell final stage in Doherty configuration, or as general purpose driver in the 1805 MHz to 2170 MHz frequency range. Available in gull wing or straight lead outline.

Table 1. Performance

Typical RF performance at T_{case} = 25 °C. Test signal: 3GPP test model 1; 64 DPCH; PAR = 9.9 dB at 0.01% probability on CCDF; specified in a class-AB production circuit.

Test signal	f	I _{Dq1} [1]	I _{Dq2} [1]	V _{DS}	P _{L(AV)}	G _p	η _D	ACPR _{5M}
	(MHz)	(mA)	(mA)	(V)	(W)	(dB)	(%)	(dBc)
single carrier W-CDMA								
carrier section	2167.5	40	120	28	4	30	24	-39.5
peaking section	2167.5	80	240	28	8	28.3	24	-36

[1] I_{Da1} represents driver stage; I_{Da2} represents final stage.

1.2 Features and benefits

- Designed for broadband operation (frequency 1805 MHz to 2170 MHz)
- High section-to-section isolation enabling multiple combinations
- High Doherty efficiency thanks to 2 : 1 asymmetry
- Integrated temperature compensated bias
- Biasing of individual stages is externally accessible
- Integrated ESD protection
- Excellent thermal stability
- High power gain
- On-chip matching for ease of use
- Compliant to Directive 2002/95/EC, regarding restriction of hazardous substances (RoHS)

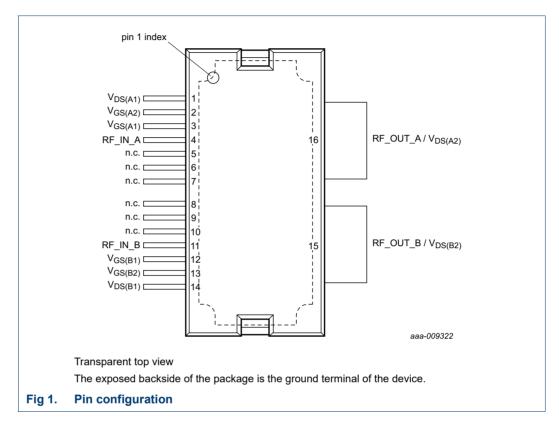
1.3 Applications

- RF power MMIC for W-CDMA base stations in the 1805 MHz to 2170 MHz frequency range. Possible circuit topologies are the following as also depicted in Section 8.1:
 - Asymmetric final stage in Doherty configuration
 - Asymmetric driver for high power Doherty amplifier

LDMOS 2-stage power MMIC

2. Pinning information

2.1 Pinning



2.2 Pin description

Table 2. **Pin description** Symbol Pin Description 1 drain-source voltage of carrier section, driver stage (A1) V_{DS(A1)} 2 gate-source voltage of carrier section, final stage (A2) V_{GS(A2)} 3 gate-source voltage of carrier section, driver stage (A1) V_{GS(A1)} RF_IN_A 4 RF input carrier section (A) 5 not connected n.c. 6 n.c. not connected 7 not connected n.c. 8 not connected n.c. 9 not connected n.c. 10 not connected n.c. RF input peaking section (B) RF_IN_B 11 12 gate-source voltage of peaking section, driver stage (B1) V_{GS(B1)} V_{GS(B2)} 13 gate-source voltage of peaking section, final stage (B2) 14 drain-source voltage of peaking section, driver stage (B1) V_{DS(B1)}

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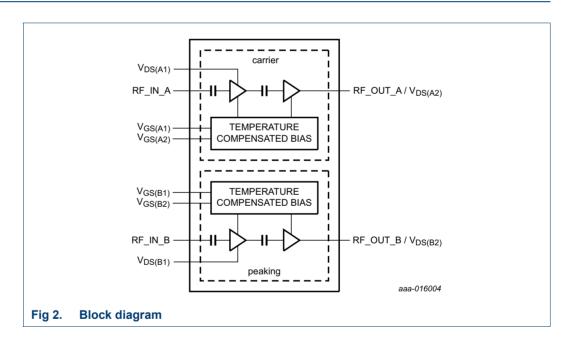
Symbol Pin Description RF_OUT_B/V_{DS(B2)} 15 RF output peaking section (B) / drain-source voltage of peaking section, final stage (B2) RF_OUT_A/V_{DS(A2)} 16 RF output carrier section (A) / drain-source voltage of carrier section, final stage (A2) GND flange RF ground

3. Ordering information

Table 3.Ordering information

Type number	Package	ickage							
	Name	Description	Version						
BLM7G1822S-80AB	HSOP16F	plastic, heatsink small outline package; 16 leads (flat)	SOT1211-2						
BLM7G1822S-80ABG	HSOP16	plastic, heatsink small outline package; 16 leads	SOT1212-2						

4. Block diagram



5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage		-	65	V
V _{GS}	gate-source voltage		-0.5	+13	V
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[1]	-	225	°C
T _{case}	case temperature		-	150	°C

[1] Continuous use at maximum temperature will affect the reliability. For details refer to the online MTF calculator.

6. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Value	Unit	
Carrier s	ection				
R _{th(j-c)}	thermal resistance from junction to case	final stage; T _{case} = 90 °C; P _L = 1.26 W	<u>[1]</u>	2.4	K/W
		driver stage; T _{case} = 90 °C; P _L = 1.26 W	<u>[1]</u>	7.6	K/W
Peaking	section				
R _{th(j-c)}	thermal resistance from junction to case	final stage; T _{case} = 90 °C; P _L = 2.52 W	<u>[1]</u>	1.5	K/W
		driver stage; T_{case} = 90 °C; P _L = 2.52 W	<u>[1]</u>	5.5	K/W

[1] When operated with a CW signal.

7. Characteristics

Table 6. DC characteristics

 $T_{\text{case}} = 25 \text{ °C}$; per section unless otherwise specified.

Symbol	Parameter	Conditions	Ν	Min	Тур	Max	Unit
Carrier s	ection						
Final stag	ge						
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0 V; I _D = 0.302 mA	6	65	-	-	V
V _{GSq}	gate-source quiescent voltage	V _{DS} = 28 V; I _D = 120 mA	1	1.6	2	2.45	V
		V _{DS} = 28 V; I _D = 120 mA	[1] 1	1.9	2.6	3.3	V
$\Delta I_{Dq} / \Delta T$	quiescent drain current variation with temperature	T _{case} = –40 °C to +85 °C	[1] -		1.5	-	%
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 28 V	-	•	-	1.4	μA
I _{DSX}	drain cut-off current	V _{GS} = 5.55 V; V _{DS} = 10 V	-		5.4	-	А
I _{GSS}	gate leakage current	V _{GS} = 1.0 V; V _{DS} = 0 V	-		-	140	nA
Driver sta	age						
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0 V; I _D = 0.058 mA	6	65	-	-	V
V _{GSq}	gate-source quiescent voltage	V _{DS} = 28 V; I _D = 40 mA	1	1.7	2.1	2.55	V
		V _{DS} = 28 V; I _D = 40 mA	[2] 1	1.9	2.6	3.2	V
$\Delta I_{Dq} / \Delta T$	quiescent drain current variation with temperature	T _{case} = -40 °C to +85 °C	[2] _		1.5	-	%
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 28 V	-		-	1.4	μA
I _{DSX}	drain cut-off current	V _{GS} = 5.55 V; V _{DS} = 10 V	-		1.05	-	А
I _{GSS}	gate leakage current	V _{GS} = 1.0 V; V _{DS} = 0 V	-		-	140	nA
Peaking	section						
Final stag	ge						
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0 V; I _D = 0.604 mA	6	65	-	-	V
V _{GSq}	gate-source quiescent voltage	V _{DS} = 28 V; I _D = 240 mA	1	1.6	2.15	2.6	V
		V _{DS} = 28 V; I _D = 240 mA	<u>[3]</u> 2	2	3	3.8	V
$\Delta I_{Dq} / \Delta T$	quiescent drain current variation with temperature	T _{case} = –40 °C to +85 °C	[3] _	•	2	-	%
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 28 V	-	•	-	1.4	μA
I _{DSX}	drain cut-off current	V _{GS} = 5.55 V; V _{DS} = 10 V	-	•	11	-	А
I _{GSS}	gate leakage current	V _{GS} = 1.0 V; V _{DS} = 0 V	-	-	-	140	nA

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Table 6. DC characteristics ... continued

 $T_{case} = 25$ °C; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Driver sta	ge					
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0 V; I _D = 0.116 mA	65	-	-	V
V _{GSq}	gate-source quiescent voltage	V _{DS} = 28 V; I _D = 80 mA	1.7	2.15	2.55	V
		V _{DS} = 28 V; I _D = 80 mA	2	2.7	3.3	V
$\Delta I_{Dq} / \Delta T$	quiescent drain current variation with temperature	$T_{case} = -40 \text{ °C to } +85 \text{ °C}$	<u>H</u> _	2	-	%
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 28 V	-	-	1.4	μA
I _{DSX}	drain cut-off current	V _{GS} = 5.55 V; V _{DS} = 10 V	-	1.9	-	А
I _{GSS}	gate leakage current	V _{GS} = 1.0 V; V _{DS} = 0 V	-	-	140	nA

[1] In production circuit with 825 Ω gate feed resistor.

[2] In production circuit with 850 Ω gate feed resistor.

[3] In production circuit with 1205 Ω gate feed resistor.

[4] In production circuit with 460 Ω gate feed resistor.

Table 7.RF Characteristics

Typical RF performance at f = 2167.5 MHz; $T_{case} = 25 \text{ °C}$; $V_{DS} = 28 \text{ V}$; $I_{Dq1} = 40 \text{ mA}$ (carrier section, driver stage); $I_{Dq2} = 120 \text{ mA}$ (carrier section, final stage); $P_{L(AV)} = 4 \text{ W}$ (carrier section); $I_{Dq1} = 80 \text{ mA}$ (peaking section, driver stage); $I_{Dq2} = 240 \text{ mA}$ (peaking section, final stage); $P_{L(AV)} = 8 \text{ W}$ (peaking section) unless otherwise specified, measured in an Ampleon straight lead production circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Carrier se	ction			-	-	
Test signal	: single carrier W-CDMA [1]					
G _p	power gain		29.5	31	32.5	dB
η _D	drain efficiency		21	24	-	%
RL _{in}	input return loss		-	-13.5	-10	dB
ACPR _{5M}	adjacent channel power ratio (5 MHz)		-	-39.5	-36.5	dBc
PARO	output peak-to-average ratio		7	7.8	-	dB
Peaking s	ection					
Test signal	: single carrier W-CDMA [1]					
G _p	power gain		26.8	28.3	29.8	dB
η _D	drain efficiency		20	24	-	%
RL _{in}	input return loss		-	-20	-10	dB
ACPR _{5M}	adjacent channel power ratio (5 MHz)		-	-36	-31	dBc
PARO	output peak-to-average ratio		5.2	7	-	dB
Test signal	: CW [2]		I		-	
$\Delta \phi_{s21}$	phase response difference	normalized; between sections	-15	-	+15	deg
$\Delta \mathbf{s}_{21} ^2$	insertion power gain difference	normalized; between sections	-0.6	-	+0.6	dB

[1] 3GPP test model 1; 64 DPCH; PAR = 9.9 dB at 0.01% probability on CCDF.

[2] f = 2170 MHz.

8. Application information

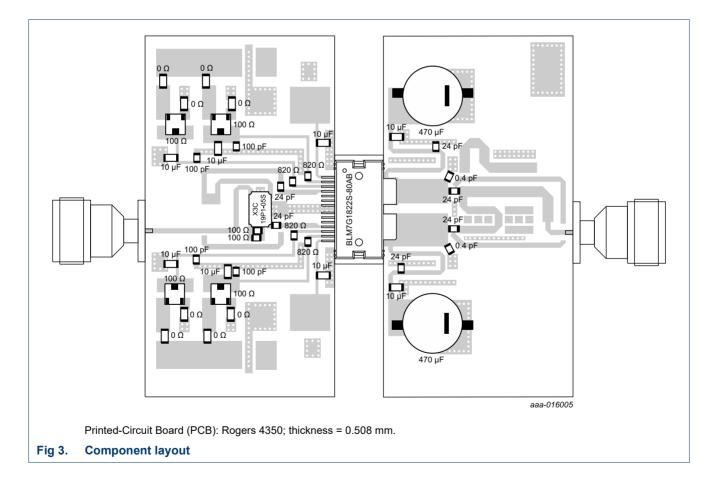
Table 8. Doherty typical performance

Test signal: 1-tone CW; RF performance at $T_{case} = 25 \ ^{\circ}C$; $V_{DS} = 28 \ V$; $I_{Dq1} = 40 \ mA$ (carrier section, driver stage); $I_{Dq2} = 90 \ mA$ (carrier section, final stage); $I_{Dq1} = 20 \ mA$ (peaking section, driver stage);

 $V_{GS} = 0.9 V$ (peaking section, final stage); unless otherwise specified, measured in an Ampleon, f = 1805 MHz to 1880 MHz, Doherty application circuit (see Figure 3 and Figure 4).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P _{L(3dB)}	output power at 3 dB gain compression	f = 1842.5 MHz; 1-tone pulsed CW (10 % duty cycle)	-	89	-	W
η _D	drain efficiency	at P _{L(3dB)} ; f = 1842.5 MHz; 1-tone pulsed CW (10 % duty cycle)	-	52.5	-	%
G _p	power gain	P _{L(AV)} = 14.12 W; f = 1842.5 MHz	-	26.3	-	dB
B _{video}	video bandwidth	P _{L(AV)} = 6.3 W; f = 1842.5 MHz; 2-tone CW	-	70	-	MHz
G _{flat}	gain flatness	P _{L(AV)} = 14.12 W	-	0.5	-	dB
К	Rollett stability factor	$T_{case} = -40 \text{ °C}; f = 0.1 \text{ GHz to 3 GHz}$ [1	l -	> 1	-	

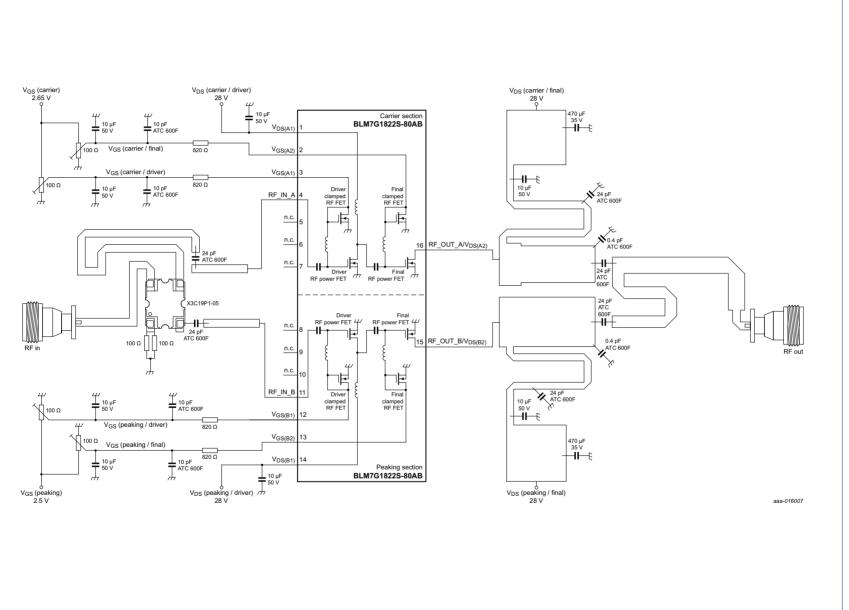
[1] For carrier and peaking sections (S-parameters measured with load-pull jig).



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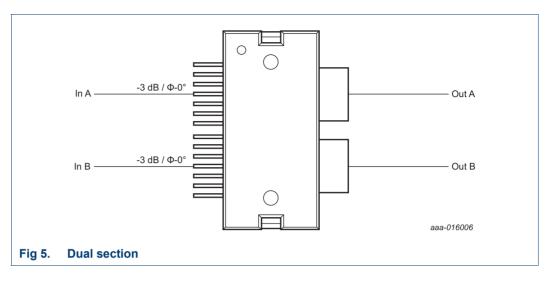
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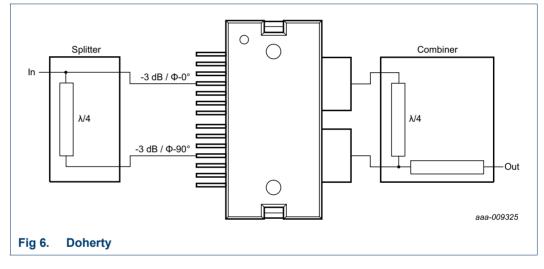
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8.1 Possible circuit topologies





8.2 Ruggedness in class-AB operation

The BLM7G1822S-80AB and BLM7G1822S-80ABG are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: f = 2140 MHz; V_{DS} = 32 V; I_{Dq1} = 40 mA (carrier section, driver stage); I_{Dq2} = 120 mA (carrier section, final stage); I_{Dq1} = 80 mA (peaking section, driver stage); I_{Dq2} = 180 mA (peaking section, final stage); P_i = 16 dBm (carrier section); P_i = 22 dBm (peaking section). P_i is measured at CW and corresponding to $P_{L(3dB)}$ under Z_S = 50 Ω load.

8.3 Impedance information

Table 9. Typical impedance

Measured load-pull data at 3 dB gain compression point; test signal: pulsed CW; $T_{case} = 25 \ C$; $V_{DS} = 28 \ V$; $t_p = 100 \ \mu$ s; $\delta = 10 \ \%$; $Z_S = 50 \ \Omega$; $I_{Dq1} = 40 \ m$ A (carrier section, driver stage); $I_{Dq2} = 110 \ m$ A (carrier section, final stage); $I_{Dq1} = 80 \ m$ A (peaking section, driver stage); $I_{Dq2} = 200 \ m$ A (peaking section, final stage). Typical values unless otherwise specified.

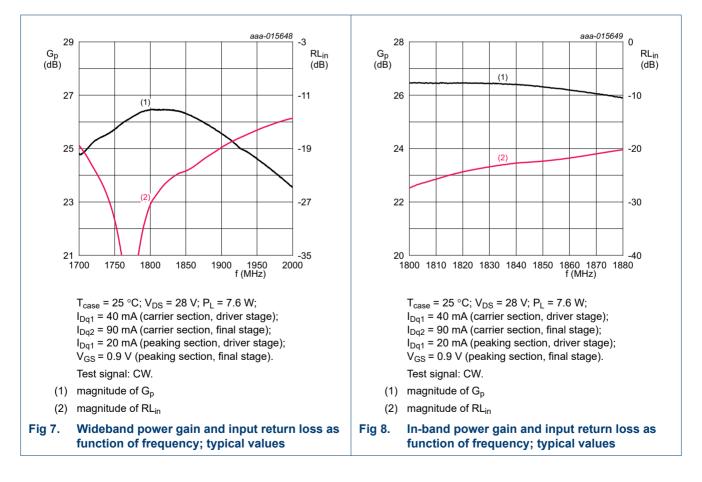
	tuned for m	aximum o	utput p	ower		tuned for maximum power added efficiency						
f	ZL	G _{p(max)}	PL	η _{add}	AM-PM conversion	ZL	G _{p(max)}	PL	η _{add}	AM-PM conversion		
(MHz)	(Ω)	(dB)	(W)	(%)	(deg)	(Ω)	(dB)	(W)	(%)	(deg)		
Carrier	section	I							I			
BLM7G1	1822S-80AB											
1805	7.7 – j10.6	32.2	45.8	51	0.3	16.7 – j4.2	33.5	43.9	58.8	-4.9		
1842.5	7.8 – j10.6	32.3	45.8	51.8	0.9	16.2 – j5.6	33.4	44	58.5	-3		
1880	7.7 – j10.6	32.3	45.8	52.1	1.4	12.2 – j4.6	33.4	44.5	58.4	-2.8		
1930	6.7 – j10.8	32	45.7	48.8	0.3	11.6 – j3.4	33.5	44.1	57.7	-4.3		
1960	7.8 – j10.6	32.6	45.7	51.4	1.6	9.9 – j4.4	33.6	44.6	57.6	-2.3		
1990	6.3 – j9.5	32.5	45.7	49.1	0.5	8.6 – j4.3	33.6	44.6	57	-3.1		
2110	6.3 – j9.5	33	45.8	51.4	-4	7.3 – j4.8	33.8	44.6	56.4	-4.4		
2140	6.3 – j9.5	33	45.7	51.8	-5.9	7.3 – j4.8	33.8	44.5	56.2	-5.4		
2170	6.8 – j10.8	32.8	45.6	50.1	-7.5	7.0 – j6.3	33.6	44.9	56.5	-7		
BLM7G1	1822S-80ABG	I			1				L			
1805	8.0 – j13.4	31.8	45.8	50.3	-1.7	14.8 – j8.7	33	44.6	58.1	-5.5		
1842.5	8.0 – j13.4	31.9	45.8	49.2	-1	16.3 – j4.3	33.3	44.7	57.5	-7.4		
1880	8.0 – j13.4	32.1	45.8	50	-0.3	12.7 – j7.1	33.2	44.5	57.3	-4.3		
1930	8.0 – j13.4	32.1	45.8	50.3	-0.6	12.8 – j7.3	33.2	44.4	56.3	-3.4		
1960	8.0 – j13.4	32.4	45.7	49.9	-0.4	11.1 – j6.8	33.5	44.5	56.1	-3.6		
1990	7.7 – j15.2	32.2	45.7	47	-0.7	9.0 – j7.7	33.4	44.8	55.9	-3.4		
2110	8.1 – j13.4	33	45.8	52.1	-6.1	7.6 – j8.0	33.6	44.7	56.1	-6.7		
2140	6.5 – j12.8	32.7	45.7	50.8	-8.9	7.6 – j8.0	33.5	44.5	55.7	-7.7		
2170	7.0 – j14.1	32.4	45.6	49.1	-10	8.6 – j9.0	33.3	44.8	55.8	-7.8		
Peaking	section											
BLM7G1	1822S-80AB											
1810	2.6 – j5.9	29.2	48.6	49.6	-2.7	5.4 – j5.1	30.3	47.4	56.4	-5.6		
1840	2.7 – j5.8	29.9	48.5	49.3	-3.8	4.9 – j4.8	30.9	47.5	56.3	-6.2		
1880	2.6 – j5.8	29.6	48.5	48.5	-2.4	4.8 – j4.3	30.6	47.4	55.3	-5		
1930	2.6 – j5.8	29.9	48.4	47.9	-1.1	4.3 – j4.2	30.8	47.4	54.3	-2.9		
1960	2.6 – j5.8	29.9	48.4	48	-1	4.2 – j4.2	30.8	47.5	54.3	-2.2		
1990	2.6 – j5.7	29.6	48.3	47.5	-2.1	3.6 – j4.0	30.4	47.4	53.8	-3.9		
2110	2.6 – j5.8	29.8	48.3	48.3	-3.6	3.1 – j4.1	30.2	47.4	52.6	-4.7		
2140	2.6 – j5.8	29.8	48.3	48.6	-4.1	3.1 – j4.7	30.3	47.6	51.9	-3.9		
2170	2.6 – j5.8	29.5	48.2	46	-5.4	2.6 – j4.7	30.1	47.5	51.2	-6.4		

Table 9. Typical impedance ...continued

Measured load-pull data at 3 dB gain compression point; test signal: pulsed CW; $T_{case} = 25 \,^{\circ}$ C; $V_{DS} = 28 \,^{\circ}$ V; $t_p = 100 \,^{\mu}$ S; $\delta = 10 \,^{\circ}$ S; $Z_S = 50 \,^{\circ}$ C; $I_{Dq1} = 40 \,^{\circ}$ MA (carrier section, driver stage); $I_{Dq2} = 110 \,^{\circ}$ MA (carrier section, final stage); $I_{Dq1} = 80 \,^{\circ}$ MA (peaking section, driver stage); $I_{Dq2} = 200 \,^{\circ}$ MA (peaking section, final stage). Typical values unless otherwise specified.

	tuned for m	naximum o	utput p	ower		tuned for m	naximum p	ower a	dded effic	iency
f	ZL	G _{p(max)}	PL	໗ _{add}	AM-PM conversion	ZL	G _{p(max)}	PL	η _{add}	AM-PM conversion
(MHz)	(Ω)	(dB)	(W)	(%)	(deg)	(Ω)	(dB)	(W)	(%)	(deg)
BLM7G	1822S-80ABG		1	I			I	1		
1810	3.0 – j8.9	29.3	48.4	50.6	-1.7	5.3 – j7.6	30.3	47.5	57.5	-5.3
1840	2.7 – j8.7	29.1	48.3	48.4	-4.4	5.0 – j7.5	30.2	47.5	56.9	-7.5
1880	3.0 – j8.8	29.4	48.4	50.5	-2.3	4.7 – j7.1	30.3	47.4	56.4	-5.1
1930	2.7 – j9.0	29.6	48.4	48.7	-2.7	4.4 – j7.0	30.6	47.4	56.1	-5.5
1960	2.7 – j9.0	29.6	48.4	48.7	-2.7	4.0 – j6.8	30.6	47.4	55.9	-5.3
1990	2.7 – j8.9	29.7	48.4	48	-2	3.8 – j7.1	30.6	47.5	55	-3.7
2110	2.7 – j9.5	29.9	48.5	49.5	-3.4	2.8 – j7.6	30.6	47.6	54.9	-4.2
2140	2.6 – j9.5	29.9	48.3	49.1	-4	2.6 – j7.9	30.5	47.6	53.7	-3.2
2170	2.4 – j9.7	29.7	48.3	47.4	-5.5	2.6 – j8.2	30.5	47.7	53	-4.6

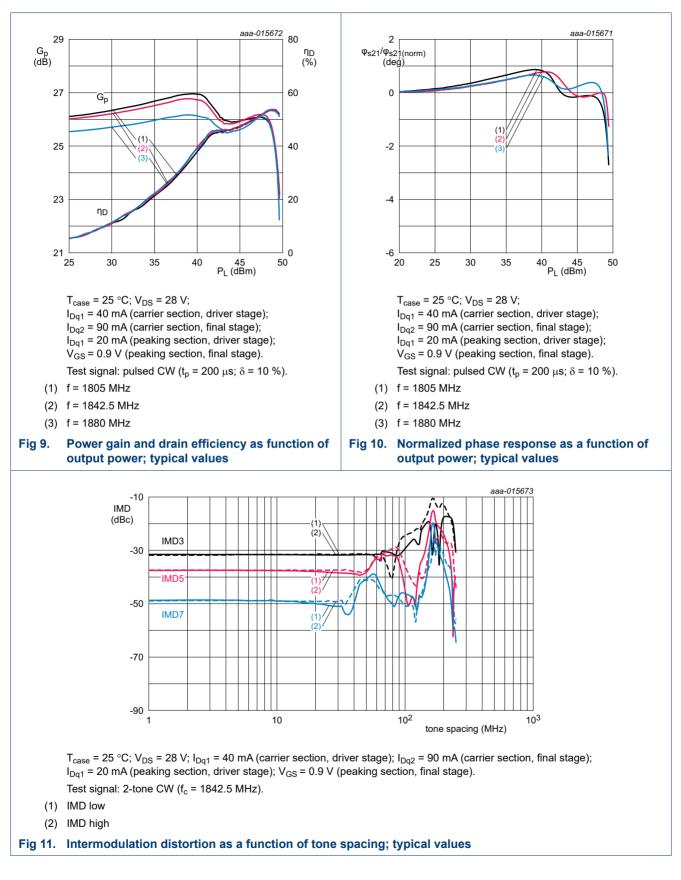
8.4 Graphs



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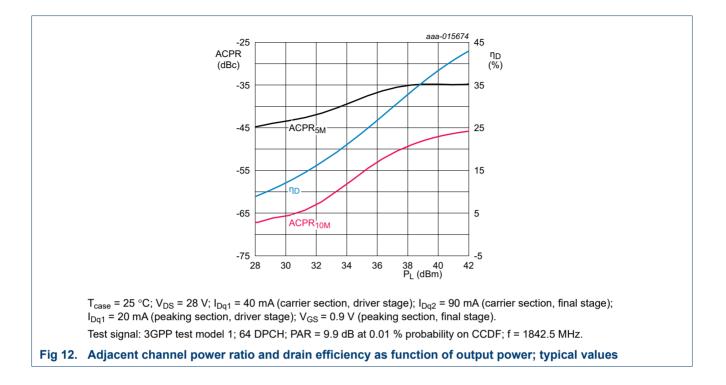
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BLM7G1822S-80AB(G)

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Product data sheet

LDMOS 2-stage power MMIC

9. Package outline

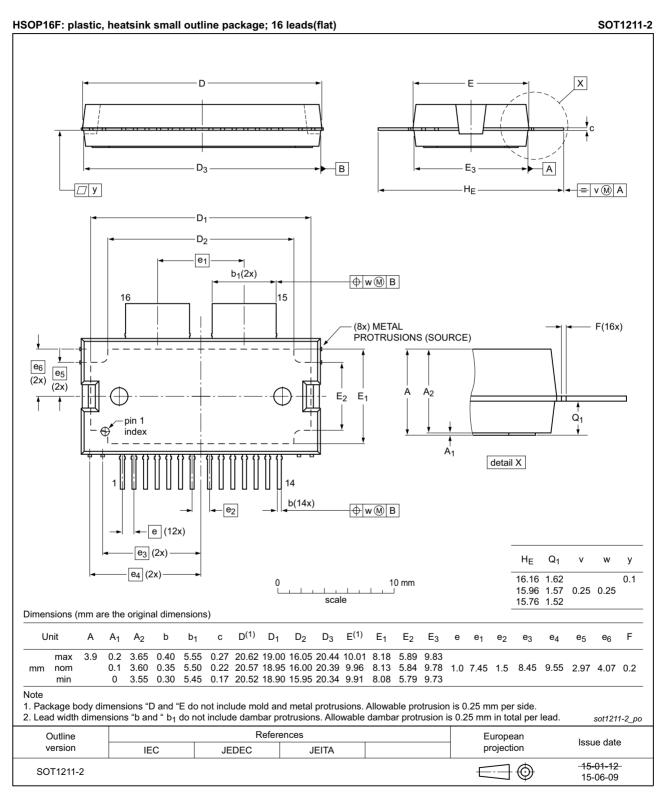
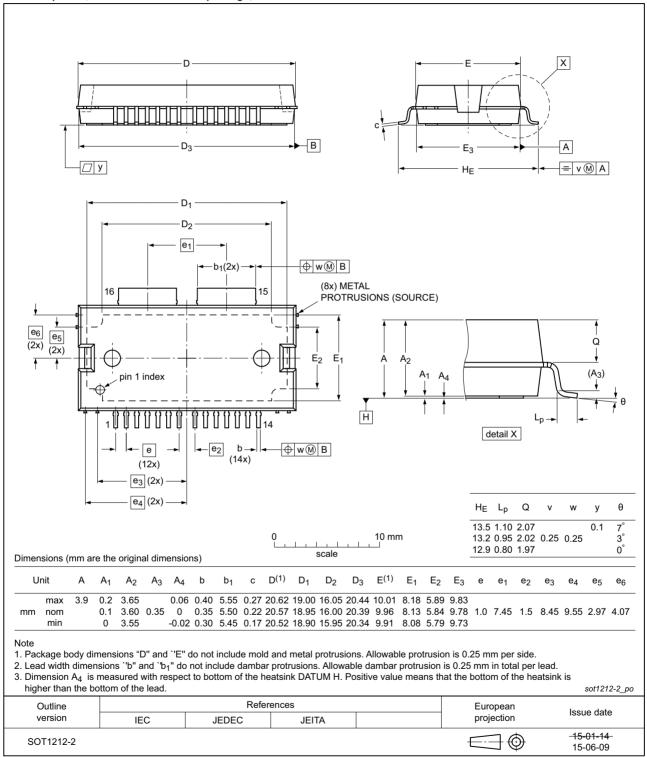


Fig 13. Package outline SOT1211-2 (HSOP16F)

LDMOS 2-stage power MMIC

SOT1212-2



HSOP16: plastic, heatsink small outline package; 16 leads

Fig 14. Package outline SOT1212-2 (HSOP16)

10. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

11. Abbreviations

Table 10. Abbre	Table 10. Abbreviations								
Acronym	Description								
AM	Amplitude Modulation								
3GPP	3rd Generation Partnership Project								
CCDF	Complementary Cumulative Distribution Function								
CW	Continuous Wave								
DPCH	Dedicated Physical CHannel								
ESD	ElectroStatic Discharge								
GEN7	Seventh Generation								
LDMOS	Laterally Diffused Metal Oxide Semiconductor								
MMIC	Monolithic Microwave Integrated Circuit								
MTF	Median Time to Failure								
PAR	Peak-to-Average Ratio								
PM	Phase Modulation								
VSWR	Voltage Standing-Wave Ratio								
W-CDMA	Wideband Code Division Multiple Access								

12. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes					
BLM7G1822S-80AB_S-80ABG#3	20150901	BLM7G1822S-80AB_S -80ABG v.2							
Modifications:	• The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.								
	 Legal texts 	have been adapted to the	e new company na	me where appropriate.					
BLM7G1822S-80AB_S-80ABG v.2	20150701	Product data sheet	-	BLM7G1822S-80AB_ S-80ABG v.1					
BLM7G1822S-80AB_S-80ABG v.1	20141128	Product data sheet	-	-					

13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.ampleon.com.

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LDMOS 2-stage power MMIC

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